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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Vitali Nesterenko et al.

Serial No.: 10/531,553

Conf. No.: 3552

Filed: May 2, 2006

For: ISOSTATIC PRESSURE
ASSISTED WAFER BONDING
METHOD

Art Unit: 2823

Examiner: Stark, Jarrett J.

RESPONSE F

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action mailed September 17, 2009, please
consider the following remarks: